

# Phosphorus-diffused LPCVD Polysilicon Passivated Contacts via Low Pressure Oxidation

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- Phosphorus-diffused Poly-Ox passivated contact, via LPCVD with in-situ low pressure oxidation.
- Lowest measured  $J_0 = 0.3 \text{ fA}\cdot\text{cm}^{-2}$ , with excellent passivation on both 1 and 100  $\Omega\cdot\text{cm}$  wafers.
- Lowest measured  $\rho_c < 1 \text{ m}\Omega\cdot\text{cm}^2$ , below measurement limit of method used.

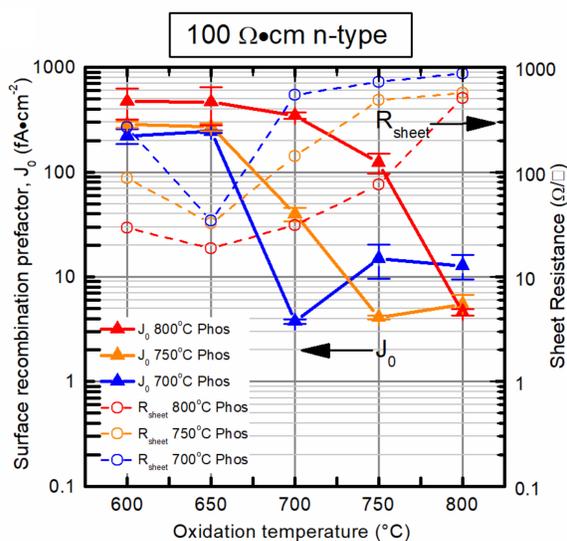
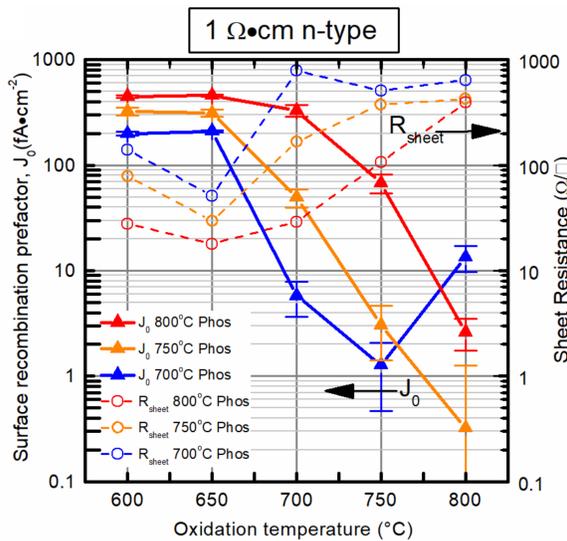
## 1. $J_0$ and $R_{\text{sheet}}$

➤ Lowest  $J_0$  was  $0.3 \pm 0.8 \text{ fA}\cdot\text{cm}^{-2}$  on 1  $\Omega\cdot\text{cm}$  wafer, and  $3.7 \pm 0.2 \text{ fA}\cdot\text{cm}^{-2}$  on 100  $\Omega\cdot\text{cm}$  wafer.

➤ Strong correlation is observed between low  $J_0$  and high  $R_{\text{sheet}}$ .

➤ Condition for excellent  $J_0$  is broad, and is achieved for a wide range of conditions.

➤ Lifetime samples measured  $\text{implied-}V_{\text{oc}} > 735 \text{ mV}$ , with bulk lifetimes  $> 70 \text{ ms}$  on 100  $\Omega\cdot\text{cm}$  wafer.

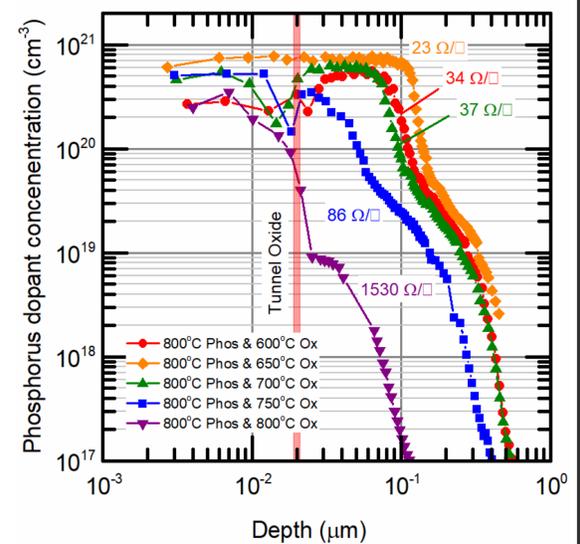


## 2. Doping profiles

➤ Strong influence of oxide thickness to the doping profile.

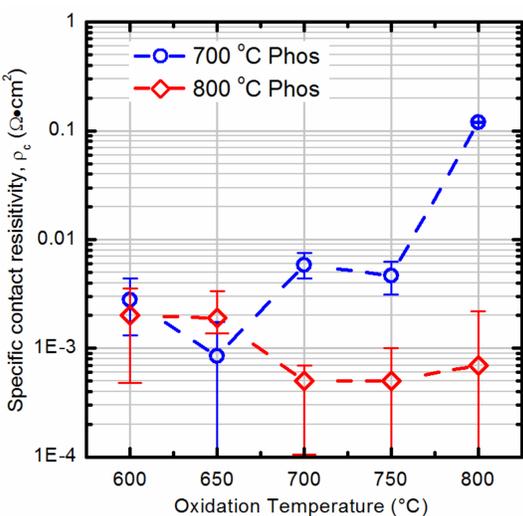
➤ Minimizing dopant penetration into Si appears paramount for low  $J_0$ .

➤ Modelling indicates high  $J_0$  for low  $R_{\text{sheet}}$  samples are due to additional recombination in the diffused region.



Oxide Temp (°C)	Measured		Modelled	
	$J_0$ ( $\text{fA}\cdot\text{cm}^{-2}$ )	$R_{\text{sheet}}$ (PCD) ( $\Omega\cdot\Box$ )	$J_0$ ( $U_{\text{Auger}}$ and $U_{\text{surf}}$ only) ( $\text{fA}\cdot\text{cm}^{-2}$ )	$R_{\text{sheet}}$ (ECV profile in Si bulk) ( $\Omega\cdot\Box$ )
600	357	29	38	34
650	355	19	15	23
700	345	31	30	37
750	123	75	21	86
800	4.6	509	0.3	1530

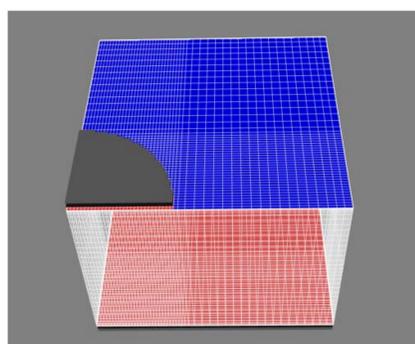
## 3. Contact Resistivity



➤  $\rho_c$  of  $< 1 \text{ m}\Omega\cdot\text{cm}^2$  is achieved for a wide range of conditions.

➤  $\rho_c$  is often below measurement limit of the method.

Measured using modified Cox and Strack (C&S) structure and fitted to Quokka 3D ohmic simulations to deduce  $\rho_c$ .



## 4. Conclusion

➤ Excellent  $J_0$  and  $\rho_c$  is achieved simultaneously  $J_0 < 3 \text{ fA}\cdot\text{cm}^{-2}$  and  $\rho_c < 1 \text{ m}\Omega\cdot\text{cm}^2$ .

➤ Oxide thickness is crucial to control phosphorus diffusion.

➤ Low  $J_0$  values are achieved with minimal diffusion into the Si bulk.

